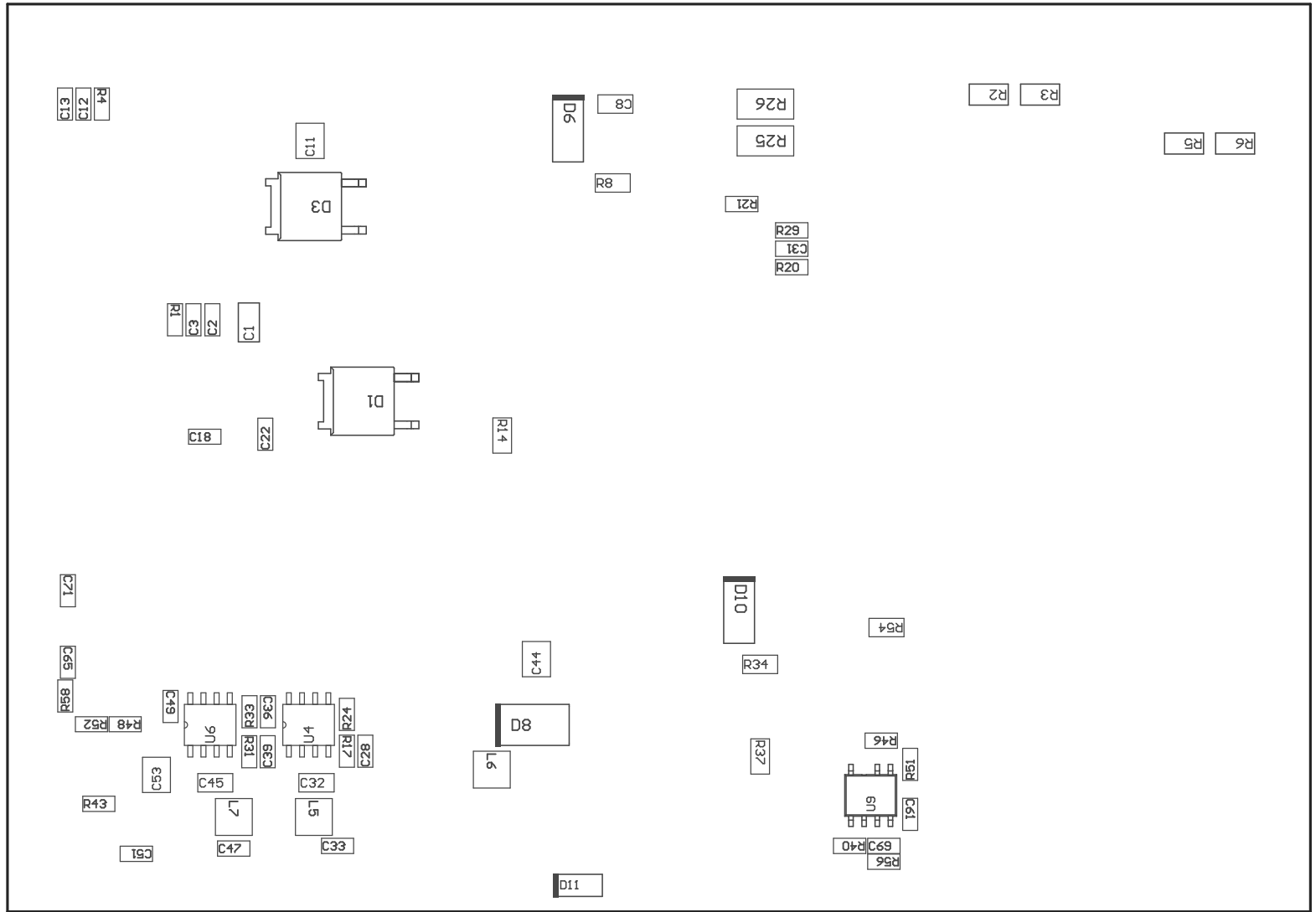


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: .VariantName

PCB VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 5/28/2015	2:35:56 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: .VariantName

PCB VIEWED FROM BOTTOM SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/28/2015	2:35:57 PM	TEXAS INSTRUMENTS

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